

CEP6060R/CEB6060R



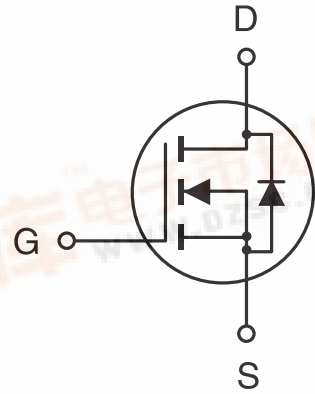
PRELIMINARY

4

N-Channel Enhancement Mode Field Effect Transistor

FEATURES

- 60V , 60A , $R_{DS(ON)}=25m\Omega$ @ $V_{GS}=10V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-220 & TO-263 package.



ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|-----------------------------------|------------|------|
| Drain-Source Voltage | V _{DS} | 60 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Drain Current-Continuous -Pulsed | I _D | 60 | A |
| | I _{DM} | 144 | A |
| Drain-Source Diode Forward Current | I _S | 60 | A |
| Maximum Power Dissipation @T _c =25°C Derate above 25°C | P _D | 100 | W |
| | | 0.7 | W/°C |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to 175 | °C |

THERMAL CHARACTERISTICS

| | | | |
|---|------------------|------|------|
| Thermal Resistance, Junction-to-Case | R _{θJC} | 2 | °C/W |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} | 62.5 | °C/W |



CEP6060R/CEB6060R

ELECTRICAL CHARACTERISTICS (T_c=25°C unless otherwise noted)

4

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|---------------------|---|-----|-----|------|------|
| DRAIN-SOURCE AVALANCHE RATING^a | | | | | | |
| Single Pulse Drain-Source Avalanche Energy | E _{AS} | V _{DD} =25V, I _D =100A | | 200 | | mJ |
| Maximum Drain-Source Avalanche Current | I _{AS} | L=25μH | | 100 | | A |
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250μA | 60 | | | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =60V, V _{GS} =0V | | | 25 | μA |
| Gate-Body Leakage | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | | | ±100 | nA |
| ON CHARACTERISTICS^a | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250μA | 2 | 2.8 | 4 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =24A | | 19 | 25 | mΩ |
| On-State Drain Current | I _{D(ON)} | V _{GS} =10V, V _{DS} =10V | 60 | | | A |
| Forward Transconductance | g _{FS} | V _{DS} =10V, I _D =24A | | 20 | | S |
| SWITCHING CHARACTERISTICS^b | | | | | | |
| Turn-On Delay Time | t _{D(ON)} | V _{DD} =30V, I _D =48A, V _{GS} =10V, R _{GS} =7.5Ω | | 15 | 20 | ns |
| Rise Time | t _r | | | 250 | 300 | ns |
| Turn-Off Delay Time | t _{D(OFF)} | | | 45 | 60 | ns |
| Fall Time | t _f | | | 130 | 150 | ns |
| Total Gate Charge | Q _g | V _{DS} =48V, I _D =48A, V _{GS} =10V | | 64 | 70 | nC |
| Gate-Source Charge | Q _{gs} | | | 8 | | nC |
| Gate-Drain Charge | Q _{gd} | | | 13 | | nC |

CEP6060R/CEB6060R

ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

4

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|-----------|--|-----|------|------|------|
| DYNAMIC CHARACTERISTICS^b | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=25\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$ | | 1178 | 1600 | pF |
| Output Capacitance | C_{oss} | | | 428 | 560 | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 95 | 130 | pF |
| DRAIN-SOURCE DIODE CHARACTERISTICS^b | | | | | | |
| Diode Forward Voltage | V_{SD} | $V_{GS}=0\text{V}, I_S=24\text{A}$ | | 0.9 | 1.3 | V |

Notes

- a. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

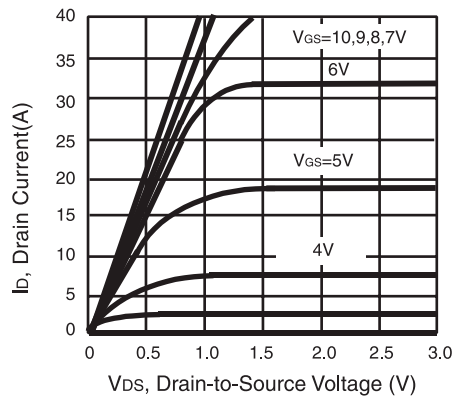


Figure 1. Output Characteristics

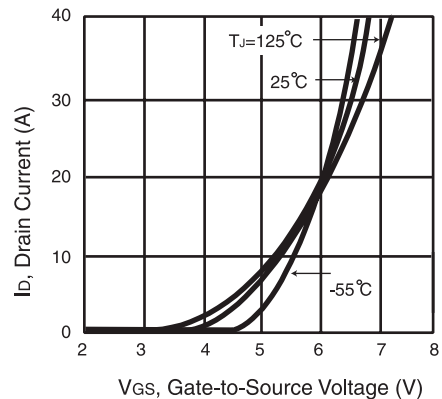


Figure 2. Transfer Characteristics

CEP6060R/CEB6060R

4

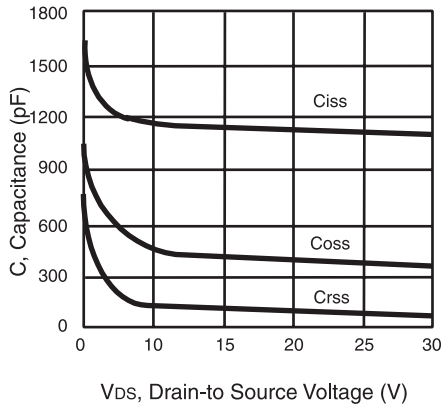


Figure 3. Capacitance

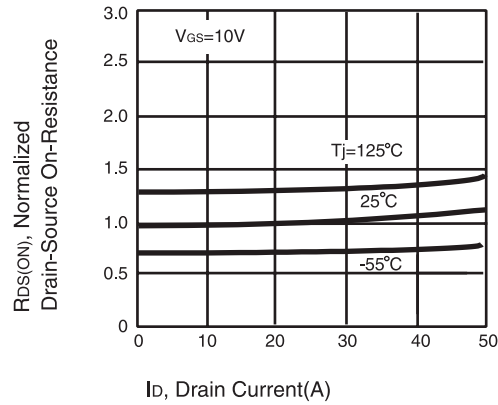


Figure 4. On-Resistance Variation with Drain Current and Temperature

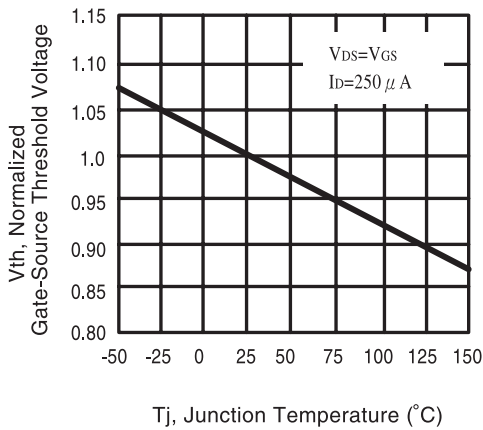


Figure 5. Gate Threshold Variation with Temperature

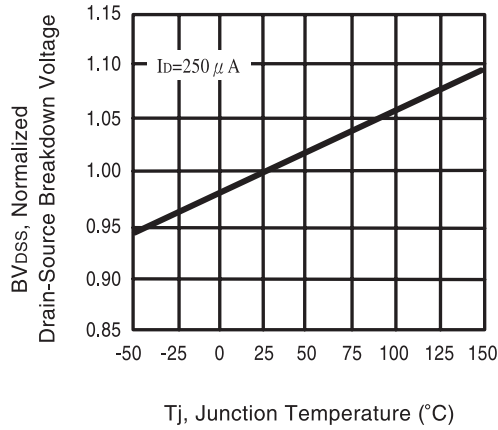


Figure 6. Breakdown Voltage Variation with Temperature

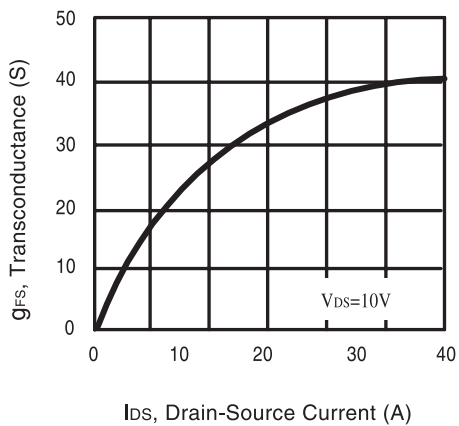


Figure 7. Transconductance Variation with Drain Current

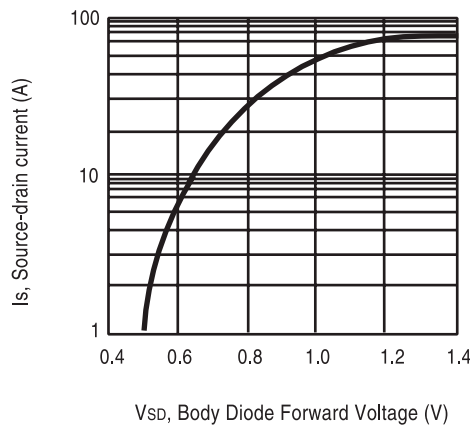


Figure 8. Body Diode Forward Voltage Variation with Source Current

CEP6060R/CEB6060R

4

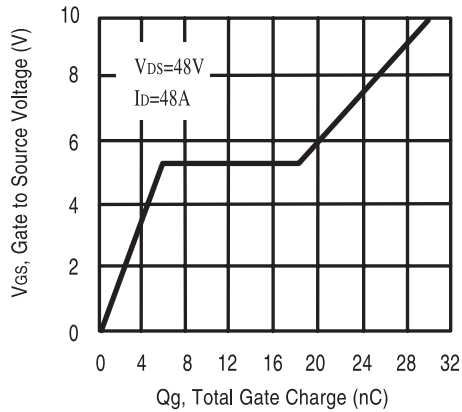


Figure 9. Gate Charge

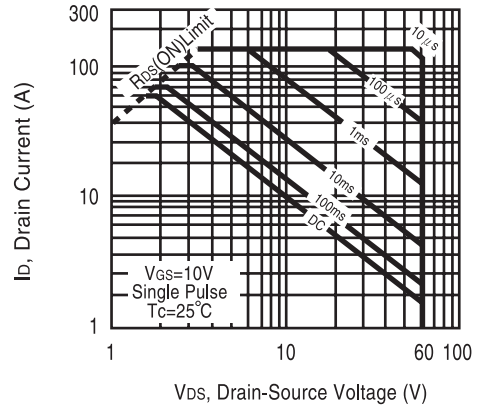


Figure 10. Maximum Safe Operating Area

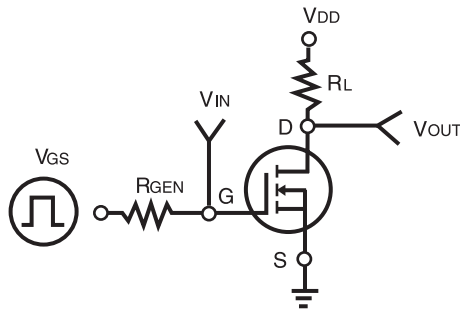


Figure 11. Switching Test Circuit

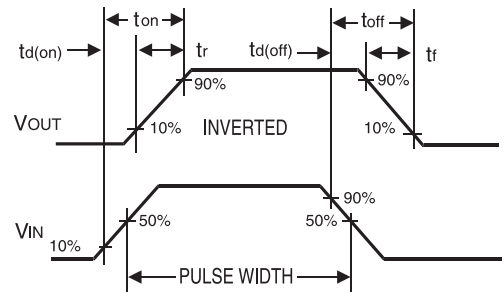


Figure 12. Switching Waveforms

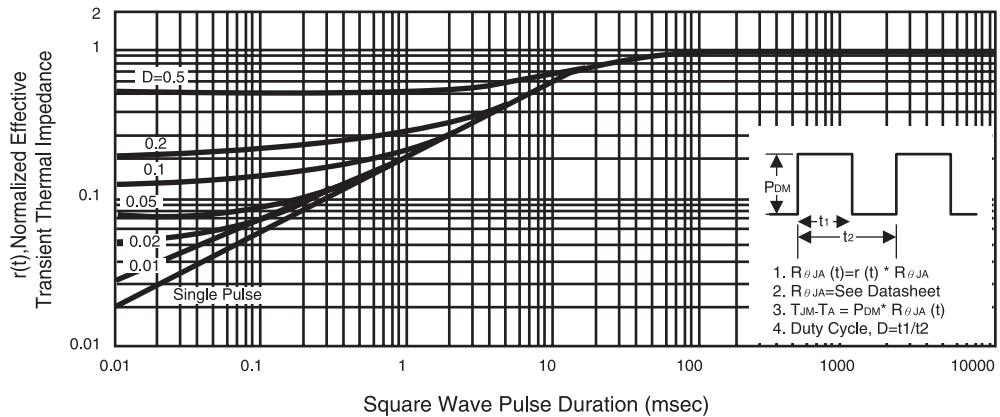


Figure 13. Normalized Thermal Transient Impedance Curve